

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



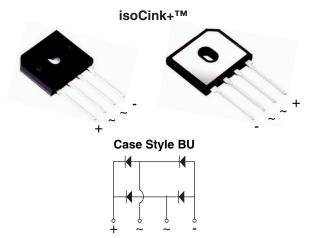




BU1206-E3, BU1208-E3, BU1210-E3

Vishay General Semiconductor

Enhanced isoCink+™ Bridge Rectifiers



* Tested to UL standard for safety electrically isolated semiconductor devices. UL 1557 4th edition. Dielectric tested to maximum case, storage and junction temperature to 150 °C to withstand 1500 V. Epoxy meets UL 94 V-0 flammability rating.

PRIMARY CHARACTERISTICS					
Package	BU				
I _{F(AV)}	12 A				
V_{RRM}	600 V, 800 V, 1000 V				
I _{FSM}	150 A				
I _R	5 μΑ				
V_F at $I_F = 6$ A	0.88 V				
T _J max.	150 °C				
Diode variations	In-Line				

FEATURES

UL recognition file number E309391 (QQQX2)
UL 1557 (see *)



• Thin single in-line package

 Available for BU-5S lead forming option (part number with "5S" suffix, e.g. BU12065S)



Superior thermal conductivity

Solder dip 275 °C max. 10 s, per JESD 22-B106

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for switching power supply, home appliances and white-goods applications.

MECHANICAL DATA

Case: BU

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: As marked on body

Mounting Torque: 10 cm-kg (8.8 inches-lbs) max. **Recommended Torque:** 5.7 cm-kg (5 inches-lbs)

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER		SYMBOL	BU1206	BU1208	BU1210	UNIT
Maximum repetitive peak reverse voltage		V_{RRM}	600	800	1000	V
Average rectified forward current (Fig. 1, 2)	$T_{\rm C} = 85 {}^{\circ}{\rm C} {}^{(1)}$	la la	12		A	
	$T_A = 25 ^{\circ}C^{(2)}$	IO	3.4			
Non-repetitive peak forward surge current 8.3 ms single sine-wave, $T_J = 25 ^{\circ}\text{C}$		I _{FSM}	150		А	
Rating for fusing (t < 8.3 ms) $T_J = 25$ °C	l ² t			93		A ² s
Operating junction and storage temperature range		T _J , T _{STG}	- 55 to + 150			°C

Notes

(1) With 60 W air cooled heatsink

(2) Without heatsink, free air

BU1206-E3, BU1208-E3, BU1210-E3

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum instantaneous forward voltage per diode (1)	I _F = 6.0 A	T _A = 25 °C	V _F	0.98	1.05	V	
		T _A = 125 °C		0.88	0.95		
Maximum reverse current per diode	rated V _R	T _A = 25 °C	I _R	-	5.0	μА	
	$T_A = 12$	T _A = 125 °C		74	250		
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	50	=	pF	

Note

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	BU1206	BU1208	BU1210	UNIT	
Typical thermal resistance	R ₀ JC (1)	2.7			°C/W	
	R _{0JA} (2)	20				

Notes

- (1) With 60 W air cooled heatsink
- (2) Without heatsink, free air

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE		DELIVERY MODE			
BU1206-E3/45	4.66	45	20	Tube			
BU1206-E3/51	4.66	51	250	Paper tray			
BU12065S-E3/45	4.66	45	20	Tube			

RATINGS AND CHARACTERISTICS CURVES (TA = 25 °C unless otherwise specified)

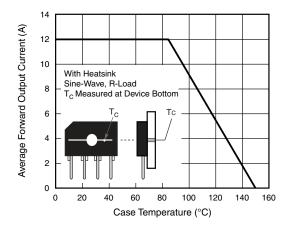


Fig. 1 - Derating Curve Output Rectified Current

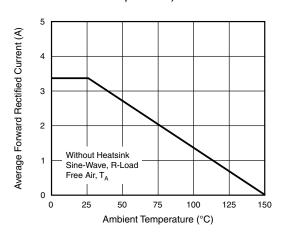


Fig. 2 - Forward Current Derating Curve





www.vishay.com

Vishay General Semiconductor

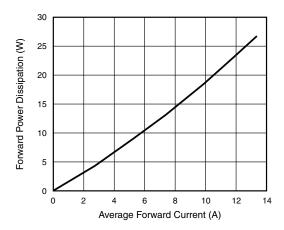


Fig. 3 - Forward Power Dissipation

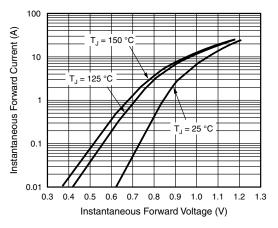


Fig. 4 - Typical Forward Characteristics Per Diode

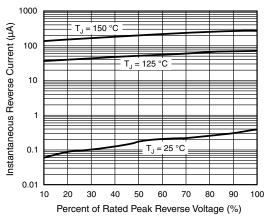


Fig. 5 - Typical Reverse Characteristics Per Diode

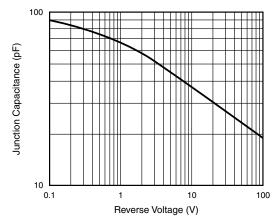


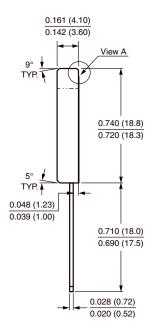
Fig. 6 - Typical Junction Capacitance Per Diode



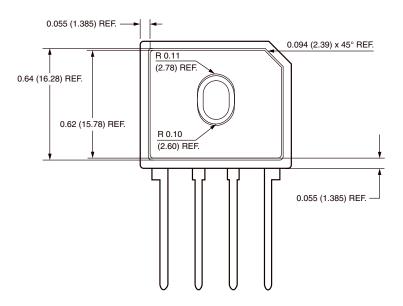
Vishay General Semiconductor

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

Case Type BU 0.880 (22.3) 0.860 (21.8) - 0.020R (TYP.) 0.125 (3.2) x 45° 0.310 (7.9) Chamfer 0.160 (4.1) 0.290 (7.4) 0.140 (3.5) 0.075 0.080 (2.03) (1.9) R 0.085 (2.16) 0.060 (1.52) 0.065 (1.65) 0.100 (2.54) 0.050 (1.27) 0.040 (1.02) 0.085 (2.16) 0.080 (2.03) 0.065 (1.65) 0.190 (4.83) 0.210 (5.33)



Polarity shown on front side of case, positive lead beveled corner

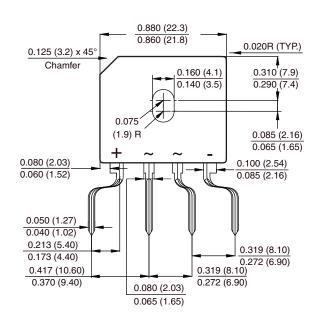


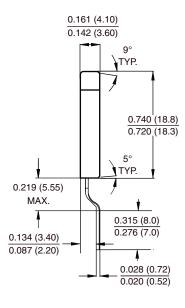




Vishay General Semiconductor

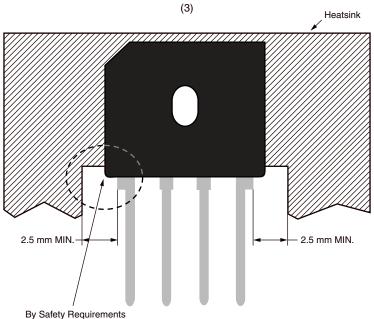
FORMING SPECIFICATION: BU-5S in inches (millimeters)





APPLICATION NOTE

- (1) Device UL approved for safety use dielectric strength of 1500 V.
- (2) If device is mounted in Floating Ground (F. G.) application, insulator is recommended to use to meet safety requirement.
- (3) Heat sink shape recommendation:





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.